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CUSTOMER . CBE005

SAMPLE CODE : SH128800T008-ZHR

MASS PRODUCTION CODE . PH128800T008-ZHR

SAMPLE VERSION . 02

SPECIFICATIONS EDITION . 005

DRAWING NO. (Ver.) . LMD-PH128800T008-ZHR (Ver.004)

PACKAGING NO. (Ver.) . PKG-PH128800T008-ZHR (Ver.001)

## **Customer Approved**

Date:

Approved	Checked	Designer
廖志豪	陳宗淇	張慶源
Rex Liao	Howard Chen	Yuan Chang

☐ Preliminary specification for design input

Specification for sample approval

## POWERT P 2025.01.13 TWRD APR.

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# **History of Version**

<u>Date</u>	<u>Ver.</u>	Edi.	<u>Description</u>	<u>Page</u>	Design by
12/12/2023	01	001	Preliminary.	-	Yuan
04/30/2024	01	002	First Sample Modify Mechanical Specifications Modify Optical Characteristics Modify Backlight Characteristics Modify Reliability Test Condition Modify Drawing	- 4 6 9 28 Appendix	Yuan
05/10/2024	01	003	ADD Optical Type	4	Yuan
10/30/2024	01	004	ADD USB interface	14 Appendix	Yuan
12/31/2024	02	005	Second Sample Modify Drawing	- Appendix	Yuan
		X			



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- 1.2 Mechanical Specifications
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- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics
- 1.7 Touch Panel Characteristics

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### 1. SPECIFICATIONS

#### 1.1 Features

<u>ltem</u>	<u>Standard Value</u>			
Screen Size(Inch)	12.1(Diagonal)			
Resolution	1280* (R · G · B) * 800 Dots			
Display Mode	Full Viewing Angle、Transmissive、Normally Black			
Color	16.7M			
Optical Type	OCR			
Weight	972g			
Interface	8 bit LVDS			
	THIS PRODUCT CONFORMS THE ROHS OF PTC			
ROHS	Detail information please refer website :			
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1			

## 1.2 Mechanical Specifications

<u>ltem</u>	Standard Value	<u>Unit</u>
Outline Dimension	305.0(W) * 200.0(L) * 13.7(H)	mm

#### **LCD Panel**

<u>ltem</u>	<u>Standard Value</u>	<u>Unit</u>
View Area	262.12(W) * 164.2(L)	mm
Active Area	261.12(W) * 163.2(L)	mm

Note: For detailed information please refer to LCM drawing.



### 1.3 Absolute Maximum Ratings

<u>Item</u>	<u>Symbol</u>	Condition	Min.	Max.	<u>Unit</u>	Remark
Logic Supply Voltage	$V_{DD}$	GND=0V	-0.3	3.6	V	
Operating Temperature	Top (Ts)	Note 1	-20	+70	°C	_
Storage Temperature	Т <sub>ST</sub> (Та)	Note 2	-30	+80	°C	_
Storage Humidity	H <sub>D</sub>	Ta<60°C	10	+90	%RH	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be

Note 1: Ts is the temperature of panel's surface.

Note 2: Ta is the ambient temperature of samples.

#### 1.4 DC Electrical Characteristics

permanently destroyed.

<u>ltem</u>	<u>Symbol</u>	<u>Condition</u>	Min.	<u> Typ.</u>	Max.	<u>Unit</u>
Power Supply Voltage for LCD Driver	VDD		3.0	3.3	3.6	V
Power Supply Current	IDD	VDD=3.3V	-	300	450	mA



## 1.5 Optical Characteristics

**TFT LCD Panel** 

VDD=3.3V, Ta=25°C

<u>Item</u>		Symbol	Condition	Min.	<u>Typ.</u>	Max.	<u>Unit</u>	-
Response Tin	ne	Tr + Tf	-	-	30	35	ms	Note2
	Тор	ΘΥ+		-	85	-		
Viouing Anglo	Bottom	ΘΥ-	CR ≥ 10	1	85	-	Dog	Note4
Viewing Angle	Left	ΘХ-	CR 2 10	•	85	-	Deg.	Note4
	Right	ΘХ+		-	85	-		
Contrast Rat	io	CR		1000	1200	-	-	Note3
	White	X	Ta = 25°C	0.23	0.28	0.33		
	vviile	Υ	$\theta X$ , $\theta Y = 0^{\circ}$	0.31	0.36	0.41		
0-1	Red	X		0.58	0.63	0.68		
Color of CIE		Υ		0.29	0.34	0.39		Note 1
Coordinate	Green	X		0.23	0.28	0.33	-	Note1
	Green	Υ		0.59	0.64	0.69		
	Divis	X		0.07	0.12	0.17		
	Blue			0.02	0.07	0.12		
Average Brightr	ness							
Pattern=white display		IV	If=300mA	650	800	-	cd/m2	Note1
(With LCD&CTP)*2								
Luminance Unifo (With LCD&CTI	•	ΔВ	If=300mA	70	-	_	%	Note1



#### Note 1:

\*1: △B=B(min) / B(max) \* 100%

\*2: Measurement Condition for Optical Characteristics:

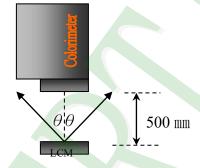
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency

b: Measurement Distance:  $500 \pm 50$  mm,  $(\theta = 0^{\circ})$ 

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





Colorimeter=BM-7 fast

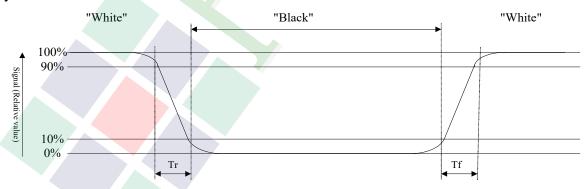
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

#### Note 2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

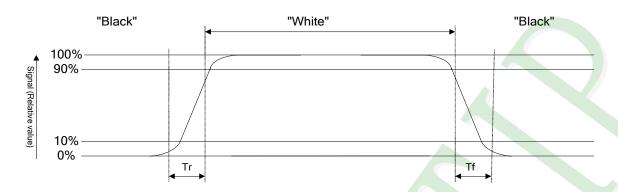
Refer to figure as below:

#### Normally White





#### Normally Black



#### Note 3: Definition of contrast ratio:

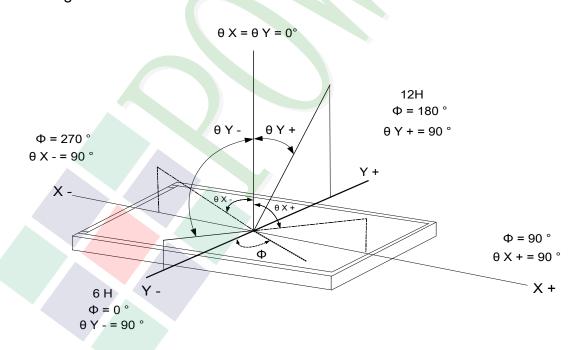
Contrast ratio is calculated with the following formula

Photo detector output when LCD is at "White" state

Contrast ratio (CR) = Photo detector output when LCD is at "Black" state

#### Note 4: Definition of viewing angle:

Refer to figure as below:





## 1.6 Backlight Characteristics

**Electrical / Optical Characteristics** 

<u>ltem</u>	Symbol	Conditions	Min.	<u>Typ.</u>	Max.	<u>Unit</u>
Forward Voltage	VF	If=300mA	29.7	33.0	36.3	V
Uniformity *1	∆B	II-300IIIA	70			
Color			White			

\*1: This value will be changed while mass production.

\*2 : △B=B(min) / B(max)% B/L Internal Circuit Diagram

Other Description

<u>Item</u>	Conditions	<u>Description</u>
Life Time	Ta =25°C If= 300 mA	30000 hrs



#### 1.7 Touch Panel Characteristics

#### 1.7.1 Features

<u>Item</u>	<u>Standard Value</u>		
Touch Panel Size	12.1"		
Touch type	Projective capacitive touch panel		
Input Method	Finger or Conductive Pen		
Support Operation	5 Points touch		
Output Interface	I2C / USB		
IC	ILI2132		

### 1.7.2 |2C Address

Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
1	0	0	0	0	0	1	R/W

#### 1.7.3 Mechanical Specifications

<u>Item</u>	Standard Value	<u>Unit</u>
Active Area	Refer LCM Drawing	mm

1.7.4 Absolute Maximum Ratings

<u>ltem</u>	<u>Symbol</u>	Condition	Min.	Max.	<u>unit</u>
Operating Temperature	Top	-	-20	+70	°C
Storage Temperature	Tst	-	-30	+80	°C

#### 1.7.5 DC Electrical Characteristics

<u>Item</u>	<u>Symbol</u>	Condition	Min.	<u>Typ.</u>	Max.	<u>unit</u>
Power Supply Voltage	VDD_3.3V	-	2.8	3.3	3.6	٧
Power Supply Voltage	VDD_5.0V	-	-	5	-	V

#### 1.7.6 Optical Characteristics

<u>Item</u>	<u>Standard Value</u>	<u>unit</u>
Total light transmittance	≥85% or more	1
Surface Hardness	≧6H	-

PCAP Firmware Information

File: 1210-021\_V0001\_V700E\_20240123.hex

SHA256: C9AAA6E8936843B9EDFFEDD32207592995340A517B3DEB6F6AA228B2C28CF1D6

Remark: None



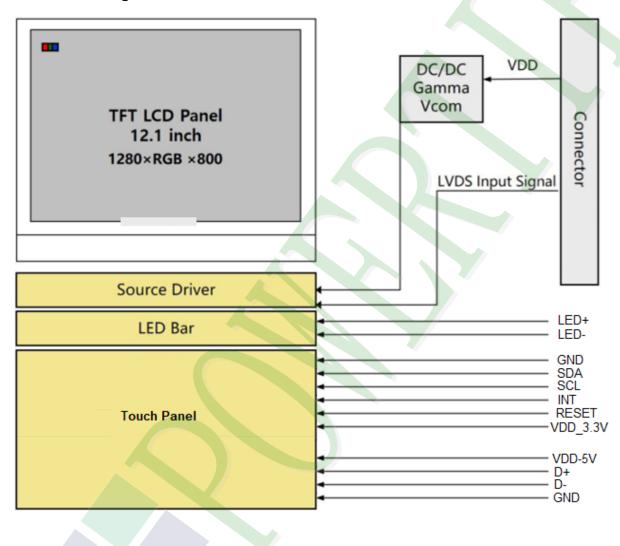
### 2. MODULE STRUCTURE

### 2.1 Counter Drawing

### 2.1.1 LCM Mechanical Diagram

\* See Appendix

#### 2.1.2 Block Diagram





#### 2.2 Interface Pin Description

#### **LCM Interface**

Pin No.	<u>Symbol</u>	<u>Description</u>
1	NC	No Connection.
2	VDD	Power Supply.
3	VDD	Power Supply.
4	VDD	Power Supply.
5	NC	No Connection.
6	GND	Ground.
7	GND	Ground.
8	RIN0-	-LVDS Differential Data Input.
9	RIN0+	+LVDS Differential Data Input.
10	GND	Ground.
11	RIN1-	-LVDS Differential Data Input.
12	RIN1+	+LVDS Differential Data Input.
13	GND	Ground.
14	RIN2-	-LVDS Differential Data Input.
15	RIN2+	+LVDS Differential Data Input.
16	GND	Ground.
17	LVDS_CLK-	-LVDS Differential Clock Input.
18	LVDS_CLK+	+LVDS Differential Clock Input.
19	GND	Ground.
20	RIN3-	-LVDS Differential Data Input.
21	RIN3+	+LVDS Differential Data Input.
22	GND	Ground.
23	NC	No Connection.
24	NC	No Connection.
25	GND	Ground.
26	SDA	Serial data input/output for I2C interface
27	SCL	Clock input for I2C interface



Pin No.	<u>Symbol</u>	<u>Description</u>
28	GND	Ground.
29	NC	No Connection.
30	NC	No Connection.
31	GND	Ground.
32	GND	Ground.
33	GND	Ground.
34	NC	No Connection.
35	NC	No Connection.
36	NC	No Connection.
37	NC	No Connection.
38	NC	No Connection.
39	NC	No Connection.
40	NC	No Connection.

## **CN1: LED Backlight Interface**

Pin No.	<u>Symbol</u>	<u>Description</u>
1	LED+	Power Supply for LED Backlight anode input
2	LED-	Power Supply for LED Backlight cathode input

## **Touch Panel interface**

## I2C interface (J2)

Pin No.	<u>Symbol</u>	<u>Description</u>
1	GND	Ground.
2	SDA	I2C Data
3	SCL	I2C Clock
4	INT	Active Low
5	RESET	Active low global reset signal input.
6	VDD_3.3V	Power Supply Voltage (3.3V)



## **USB** interface (J4)

Pin No.	Symbol	<u>Description</u>
1	VDD-5V	Power Supply for CTP
2	D-	USB_N for CTP
3	D+	USB_P for CTP
4	GND	Ground.
5	GND	Ground.

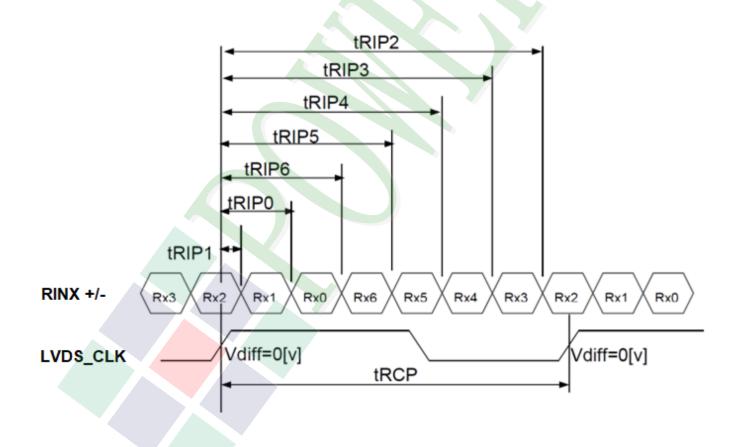


## 2.3 Timing Characteristics

## 2.3.1 LVDS Rx Interface Timing Parameter

The specification of the LVDS Rx interface timing parameter

	<u> </u>					
<u>ltem</u>	<u>Symbol</u>	Min.	<u>Typ.</u>	Max.	<u>Unit</u>	<u>Remark</u>
LVDS_CLK	tRCP	10	Т	40	nsec	-
Period						
Receiver Data	tRMG	-0.45	-	+0.45	nsec	fCLKIN=80.9MHz
Input Margin		-0.60	-	+0.60	nsec	fCLKIN=75MHz
Input Data 0	tRIP1	-   tRMG	0.0	+   tRMG	Clock	
Input Data 1	tRIP0	T/7-   tRMG	T/7	T/7+   tRMG	Clock	-
Input Data 2	tRIP6	2 T/7-   tRMG	2T/7	2 T/7+   tRMG	Clock	-
Input Data 3	tRIP5	3 T/7-   tRMG	3T/7	3 T/7+   tRMG	Clock	-
Input Data 4	tRIP4	4 T/7-   tRMG	4T/7	4 T/7+   tRMG	Clock	-
Input Data 5	tRIP3	5 T/7-   tRMG	5T/7	5 T/7+   tRMG	Clock	-
Input Data 6	tRIP2	6 T/7-   tRMG	6T/7	6 T/7+   tRMG	Clock	-



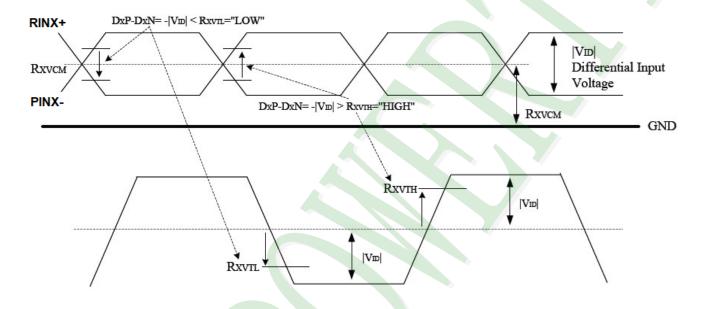


### 2.3.2 DC Specification

LVDS Receiver Differential Input ( DC Characteristics ).

<u>Parameter</u>	Symbol	Min.	Typ.	Max.	<u>Unit</u>	Conditions
Differential Input High Threshold	Vth	-	-	100	mV	V <sub>CM</sub> =+1.2V
Differential Input Low Threshold	VtI	-100	-	-	mV	V <sub>CM</sub> =+1.2V
Differential Input Voltage	V <sub>ID</sub>	200	-	600	mV	-
Common Mode Voltage	V <sub>CM</sub>	1	1.2	1.4	V	-

#### Single-end Signals

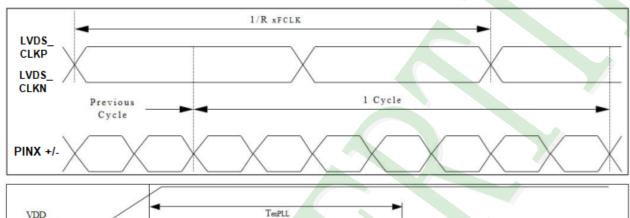


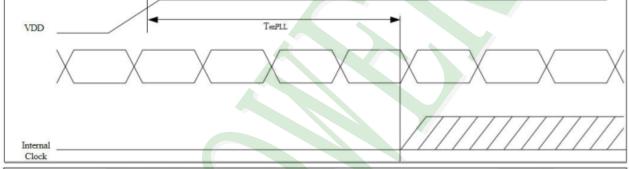


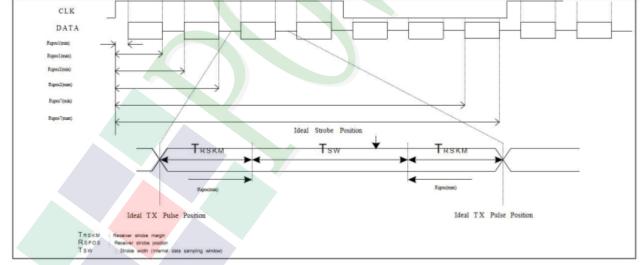
## 2.3.3 AC Specification

LVDS Receiver Differential Input ( AC Characteristics )

<u>Parameter</u>	<u>Symbol</u>	Min.	<u>Typ.</u>	Max.	<u>Unit</u>	<u>Note</u>
LVDS Strobe Width	tSW	200	-	•	ps	$V_{CM}$ =+1.2V VID = 200mV
LVDS Receiver Skew Margin	tRSM	500	-	-	ps	@81MHz









2.3.4 Input Timing (DE mode only)

<u>Parameter</u>	<u>Symbol</u>	Min.	<u>Typ.</u>	Max.	<u>Unit</u>
LVDS Frequency@Frame rate=60Hz	Fclk	69.7	75	80.9	MHz
Horizontal display area	THD		1280		DCLK
HSYNC period time	Тн	1410	1440	1500	DCLK
HSYNC blanking	THBP+THFP	100	160	220	DCLK
Vertical display area	Tvd		800		Н
VSYNC period time	Tv	842	838	872	Н
VSYNC blanking	TVBP+TVFP	24	38	72	Н

#### Note

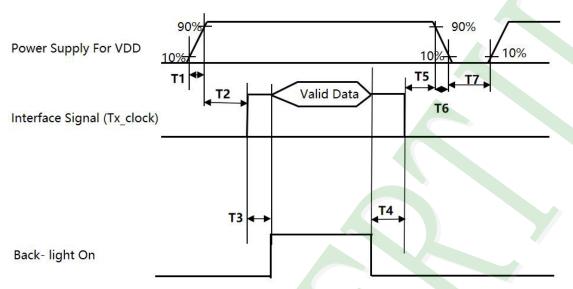
- DE Only Mode , While operation, DE signal should be have the same cycle. The input of HSYNC & VSYNC signal does not have an effect on normal operation.
- 2. Best operation clock frequency is 75Mhz.
- 3. Frequency] = [H Total] \* [V Total] \* [vertical Frame rate]
  H Total, V Total and Frame rate]should operate within the range between Frequency\_
  Min and Frequency\_Max
- 4. Except Best operation clock frequency, FOS(Flicker & Brightness & Crosstalk, Etc.) are not guaranteed.
- 5. Main frequency Max is 80.9Mhz MHz without spread spectrum





#### 2.3.4 Power ON/OFF Sequence

To prevent a latch-up or DC operation of the Open Cell, the power on/off sequence shall be as shown in below



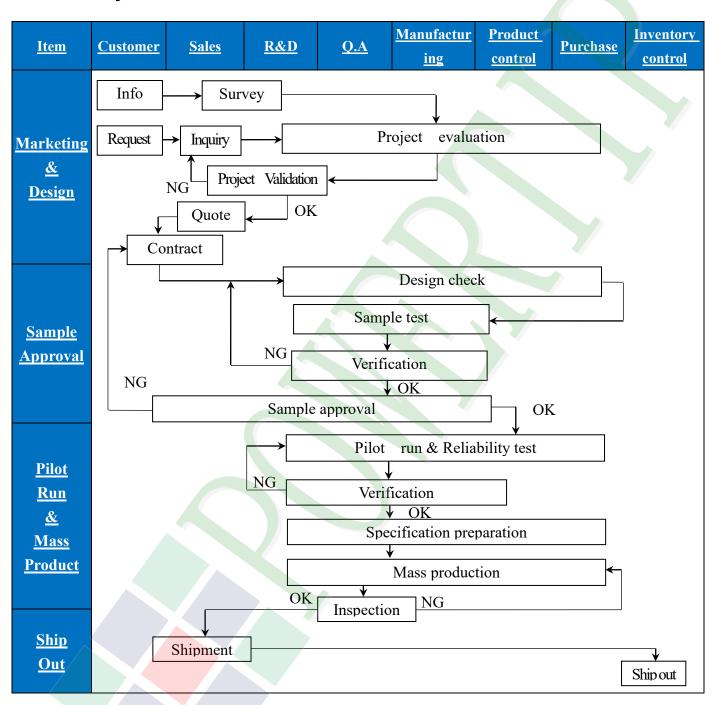
<u>Parameter</u>	Min.	<u>Typ.</u>	Max.	<u>Unit</u>
T1	0.1	-	10	ms
T2	0.1	-	50	ms
Т3	300	-	-	ms
T4	200	-	-	ms
T5	0.1	-	50	S
T6	0.1	-	10	ms
T7	500	-	-	ms

- Note 1: Even though T1 is over the specified value, there is no problem if the rush current is within Spec.
- Note 2: When the power supply VDD is 0V, keep the level of input signals on the low or high impedance;
  - Please avoid floating state of interface signal at invalid period.
  - ※ When the power supply for LCD (VDD) is off, be sure to pull down the valid and invalid data to 0V.
- Note 3: The T3 / T4 is recommended value, the case when failed to meet a minimum specification, abnormal display would be shown. There is no reliability problem.
- Note 4: T6: Voltage of VDD must decay smoothly after power-off, there should be none re-bounding voltage. (customer system decide this value)
- Note 5: T7 should be measured after the Module has been fully discharged between power off and on period

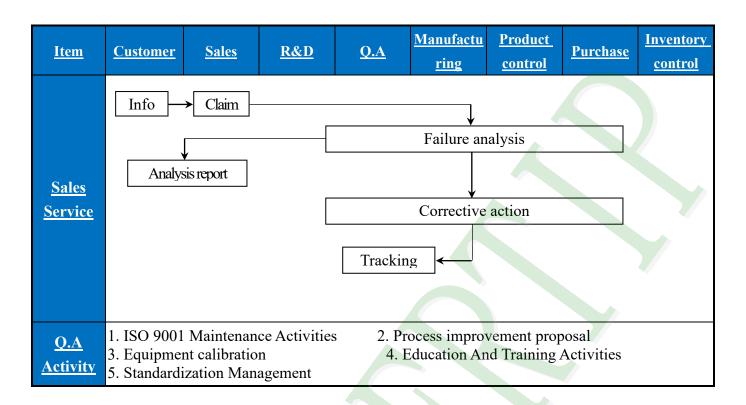


### 3. QUALITY ASSURANCE SYSTEM

### 3.1 Quality Assurance Flow Chart









#### 3.2. Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3. 5" -15″ (Ver.B01).

♦ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.

**◆**Equipment: Gauge, MIL-STD, Powertip Tester, Sample

◆Defect Level: Major Defect AQL: 0. 4; Minor Defect AQL: 1. 5

**♦**OUT Going Defect Level: Sampling.

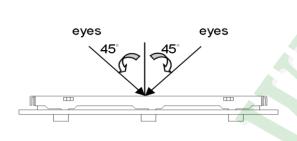
◆Standard of the product appearance test:

a. Manner of appearance test:

(1). The test best be under  $20W\times2$  fluorescent light(about  $300lux \sim 500lux$ )

, and distance of view must be at 30~40 cm.

(2). The test direction is base on about around 45° of vertical line.



5% Brightness

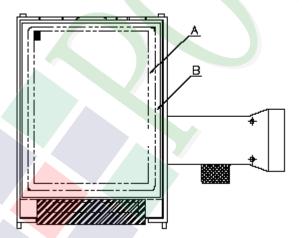
ND fliter

30~40 cm

LCD panel

2.5~3cm

(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3. 5" ~15":

NO	<u>Item</u>	<u>Criterion</u>	Level				
		1. 1The part number is inconsistent with work order of production.	Major				
01	Product condition	1. 2 Mixed product types.	Major				
		. 3 Assembled in inverse direction.					
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major				
03	Outline dimension	3. 1Product dimension and structure must conform to structure diagram.	Major				
		4. 1 Missing line character and icon.	Major				
		4. 2 No function or no display.	Major				
		4. 3 Display malfunction.	Major				
04	Electrical Testing	4. 4 LCD viewing angle defect.	Major				
		4. 5 Current consumption exceeds product specifications.	Major				
		4. 6Mura cannot be seen through 5% ND filter at 50% Gray, should be judged by the viewing angle of 90 degree.					
05	Dot defect  (Bright dot, Dark dot)  On -display	Item       Acceptance (O'ty)         Bright Dot       ≤ 4         Defect       Joint Dot       ≤ 3         Total       ≤ 7         5.1 Inspection pattern: full white, full black, Red, Green and blue screens.         5.2 It is defined as dot defect if defect area > 1/2 dot.         5.3 The distance between two dot defect ≥5 mm.         5.4 Bright dot: Dots appear bright and unchanged in visible with 5% ND filter is defined.         5.5 Tiny bright dot: bright dot area ≤ 1/2 dot.         a. Dots appear bright and unchanged in visible with 5% ND filter is defined defect and is judged in accordance with 6.1 b. Dots invisible with 5% ND Filter is Ignored.	Minor				



## ◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	<u>Item</u>	Criterion	Level
		6. 1 Round type (Non-display or display):	
06	Black or white Dot, scratch, contamination  Round type  → X ← Y  Y  Φ = (x+y)/  2  Line type  L  L	$ \begin{array}{ c c c c c }\hline Dimension (diameter: \Phi) & Acceptance (O'tv) \\ \hline & \Delta area & B area \\ \hline & \Phi \leq 0.25 & Ignore \\ \hline & 0.25 < \Phi \leq 0.50 & 5 \\ \hline & \Phi > 0.50 & 0 \\ \hline & Total & 5 \\ \hline \\ \hline & & & & & & & & & & & & & & & &$	Minor
07	Polarizer Bubble	$\begin{array}{c cccc} \underline{Dimension~(diameter: \Phi)} & \underline{Acceptance~(Q'ty)} \\ \underline{A~area} & \underline{B~area} \\ \hline & \Phi \leq 0.25 & Ignore \\ \hline & 0.25 < \Phi \leq 0.50 & 4 \\ \hline & 0.50 < \Phi \leq 0.80 & 1 & Ignore \\ \hline & \Phi > 0.80 & 0 \\ \hline & Total & 5 & \\ \hline \end{array}$	Minor



### ◆Specification For TFT-LCD Module 3. 5″ ~15″:

<u>NO</u>	<u>Item</u>	<u>Criterion</u>	Level
		Symbols:  X: The length of crack Z: The thickness of crack T: The thickness of glass  X: The width of crack W: terminal length a: LCD side length	
		8.1 General glass chip: 8.1.1 Chip on panel surface and crack between panels:	
		Z Z Y	
08	The crack of glass	SP SP [NG]	Minor
		Seal width Z	
		X Y Z	
		≤ a Crack can't enter viewing area ≤1/2 t	
		≦a Crack can't exceed the half of SP width. 1/2 t < Z ≦2 t	



## ◆Specification For TFT-LCD Module 3. 5″~15″:

<u>NO</u>	<u>Item</u>	<u>Criterion</u>	Level
		Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  8. 1. 2 Corner crack:	
		<u>X</u> <u>Y</u> <u>Z</u>	
		≤1/5 a Crack can't enter viewing area Z ≤ 1/2 t	
		≤1/5  a Crack can't exceed the half of SP width. $1/2$ t < Z $≤2$ t	
08	The surel of slave		M:
08	The crack of glass	8.2 Protrusion over terminal:	Minor
		8.2.1 Chip on electrode pad:	
		Z X Y Z	
		W X	
		<u>X</u> <u>Y</u> <u>Z</u>	



## ◆Specification For TFT-LCD Module 3. 5″~15″:

Symbols:	
X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 2. 2 Non-conductive portion:	gth
The crack of glass  The crack of glass  If the chipped area touches the ITO terminal, the ITO must remain and be inspected according terminal specifications  8. 2. 3 Glass remain: $ \frac{X}{y}  \underline{y}  \underline{z} $ $ \leq a  \leq 1/3 \text{ W}  \leq t $	over 2/3 of
W t	w W



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion Criterion	Level
		9. 1 Backlight can't work normally.	Major
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
		10. 1 Pin type, quantity, dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC.	Major
	General	10. 3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major
10	appearance	10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



### 4. RELIABILITY TEST

#### **Reliability Test Condition** 4.1

(Ver.B01)

TEOT	TEST CONDITION				
<u>IESTIIEM</u>	TEST CONDITION				
High Temperature Storage Test	Keep in +80 ±5°C 240 hrs				
High Temperature Operating Test	Keep in 70 ±5°C 240 hrs				
Low Temperature Storage Test	Keep in -30 ±5℃ 240 hrs				
Low Temperature Operating Test	Keep in -20 ±5°C 240 hrs				
High Temperature / High Humidity Storage Test	Keep in 60 ℃ / 90% R.H duration for 240 hrs (Excluding the polarizer)				
Temperature Cycling Storage Test	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$				
ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-  1.Temperature ambiance: $15^{\circ}\text{C} \sim 35^{\circ}\text{C}$ 2.Humidity relative: $30\% \sim 60\%$ 3.Energy Storage Capacitance(Cs+Cd): $150\text{pF}\pm10\%$ 4.Discharge Resistance(Rd): $330\Omega\pm10\%$ 5.Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec)  (Tolerance if the output voltage indication: $\pm5\%$ )				
Vibration Test (Packaged)	<ul> <li>1.Sine wave 10∼55 Hz frequency (1 min/sweep)</li> <li>2.The amplitude of vibration :1.5 mm</li> <li>3.Each direction (X · Y · Z) duration for 2 Hrs</li> </ul>				
Drop Test (Packaged)	Packing Weight (Kg) Drop Height (cm)  0 ~ 45.4 122  45.4 ~ 90.8 76  90.8 ~ 454 61  Over 454 46  Drop Direction : 1 corner / 3 edges / 6 sides each 1 time				
	Storage Test  High Temperature Operating Test  Low Temperature Storage Test  Low Temperature Operating Test  High Temperature / High Humidity Storage Test  Temperature Cycling Storage Test  ESD Test  Vibration Test (Packaged)  Drop Test				

#### ○ Result Evaluation Criteria:

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function. (Normal operation state)

Temperature: +20~30°C Humidity: 50~70%

Atmospheric pressure: 86~106Kpa



#### 5. PRECAUTION RELATING PRODUCT HANDLING

#### 5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### **5.2 HANDLING**

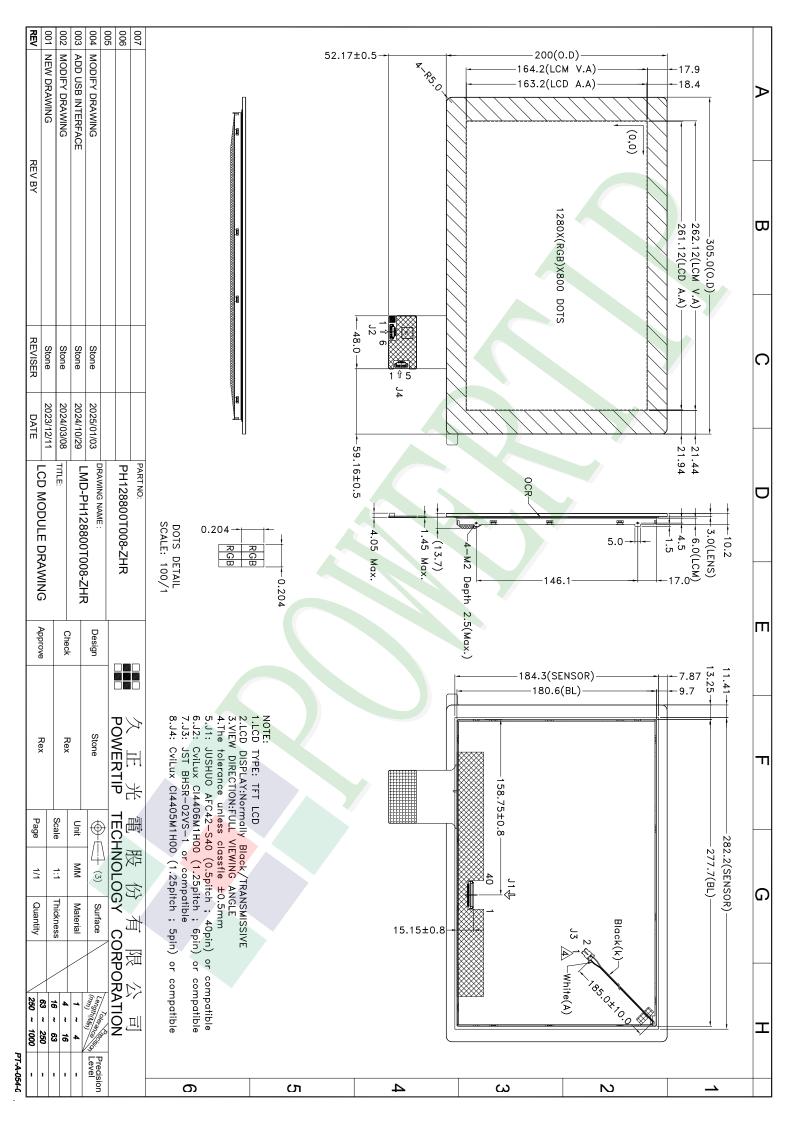
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM
- 5.2.10 Caution!( LCM products with Capacitive Touch Panel)
  Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
  - Therefore, the touch needs to be thoroughly tested inside the target application.
- 5.2.11 CAUTION: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.
- 5.2.12 Double-sided tape designed to be attach with the customer's mechanical device, please follow up the rules and regulations published by the original manufacturer of double-sided tape for the attachment operation.

#### 5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

#### 5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
  - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Ver	.001				Approve	Check	Contact
	uments NO.	PKG-PH128800T008-Z	Packaging	Specifications	Rex	Rex	Stone
l.Pa	ackaging Ma	terial: (per carton	)				
No.		Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)		PH128800T008-ZHR	305.0 X 200.0	0.972	18	17.496
2	靜電袋(1)Ar	ntistatic Bag	BAG000000053	350 X 450	0.02	18	0.36
3	上蓋(2)EPE(	Cover)	FOAM00000197	510 X 355 X 55	0.16	1	0.16
4	下座(3)EPE(		FOAM00000198	510 X 355 X 100	0.34	1	0.34
5	外紙箱(4)Ca	irton	BX53537327CCBA	535 X 373 X 265	1.1624	1	1.1624
6	*******						
2.一 3.單	· 整稍總里重 箱數量規格。	(Total LCD Weight i	n carton ): 19.52 Kg±: cations and Quantity):	10%			
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